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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/767,764	01/29/2004	Max F. Hineman	2269-5925US 5543 (03-0290.00/U	
<sup>24247</sup> TRASK BRIT	7590 02/27/2007 ITT		EXAMINER	
P.O. BOX 2550			QUINTO, KEVIN V	
SALT LAKE CITY, UT 84110			ART UNIT	PAPER NUMBER
			2826	
SHORTENED STATUTO	RY PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE	
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# Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

<u> </u>	Application No.	Applicant(s)				
	10/767,764	HINEMAN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Kevin Quinto	2826				
The MAILING DATE of this communication app Period for Reply	oears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status	•					
1)⊠ Responsive to communication(s) filed on 30 J	anuary 2007.					
·_ ·	action is non-final.					
·= ·=	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4)⊠ Claim(s) <u>1-25</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-25</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/o	r election requirement.					
Application Papers						
9) The specification is objected to by the Examine	r ·					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correct	•	• •				
11) The oath or declaration is objected to by the Ex						
Priority under 35 U.S.C. § 119						
<u></u>	priority under 25 H C C \$ 110(a)	(4) (5)				
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of:						
1.☐ Certified copies of the priority document	a have been received					
		on No				
<ul><li>2. Certified copies of the priority document</li><li>3. Copies of the certified copies of the priority</li></ul>	· •					
application from the International Bureau	•	d in this National Stage				
• •	` ''	d				
* See the attached detailed Office action for a list of the certified copies not received.						
Attachment(s)						
1) Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date						
Information Disclosure Statement(s) (PTO/SB/08)   Paper No(s)/Mail Date	5)  Notice of Informal Page 6) Other:	atent Application				

#### **DETAILED ACTION**

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## Response to Arguments

- 1. The amendment under 37 CFR § 1.116 dated January 30, 2007 has been entered.
- 2. In the below Office action, the examiner has rejected claims 1-16, 20, 22, and 24-25 under 35 U.S.C. 102(b) as being anticipated by Aoki et al. (USPN 6,465,352 B1) and claims 17, 18, 19, 21, and 23 have been rejected under 35 U.S.C. 103 as being unpatentable over Aoki (claims 17, 18, and 19) as well as in view of Yamasaki et al. (United States Patent Application Publication No. US 2001/0034127 A1 - claim 21) and Andrews et al. (USPN 6,270,353 B1 – claim 23). In the arguments (filed October 5, 2005) concerning figures 7A-7F of the Aoki reference (USPN 6,465,352 B1), the applicant asserts that Aoki prevents the oxidation of the copper film (p. 10 of the response) and does not expose the copper to oxidation injury (p. 11). However it is clear that the copper film of Aoki does experience oxidation injury. Aoki discloses, in figure 9, that the copper does experience oxidation injury. Therefore claims 1-16, 20. 22, and 24-25 are anticipated by figures 7A-7F of Aoki and claims 17, 18, 19, 21, and 23 have been rejected under 35 U.S.C. 103 as being unpatentable over Aoki (claims 17. 18, and 19) as well as in view of Yamasaki et al. (United States Patent Application Publication No. US 2001/0034127 A1 – claim 21) and Andrews et al. (USPN 6,270,353) B1 - claim 23).

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## Claim Rejections - 35 USC § 102

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3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1-16, 20, 22, 24, and 25 are rejected under 35 U.S.C. 102(b) as being anticipated by Aoki et al. (USPN 6,465,352 B1).
- 5. In reference to claim 1, by Aoki et al. (USPN 6,465,352 B1, hereinafter referred to as the "Aoki" reference) discloses a similar method. Figures 7A-7F of Aoki illustrates a method for forming a damascene structure which meets claims 1. A damascene opening is formed to expose a metallic layer (3) in a damascene structure. The metallic layer (3) is exposed to a reducing plasma to at least partly reverse an oxidation injury (column 6, lines 46-67) to the metallic layer (3). A cleaning process is applied to the damascene structure (column 9, lines 34-48). A metallic plug (22) is formed in the damascene opening such that it is in electrical connection with the metallic layer (3).
- 6. With regard to claims 2, 3, and 4, the metallic layer (3) is formed of copper (column 8, lines 57-60), a metal which the applicant has characterized as having an easily reducible oxide (p.10, paragraph 45 of applicant's current specification).
- 7. In reference to claim 5, hydrogen plasma is used as the reducing plasma (column 6, lines 46-67).
- 8. With regard to claims 6 and 7, the hydrogen plasma includes nitrogen as an inert gas (column 9, lines 16-29).

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9. In reference to claims 8 and 9, Aoki meets these limitations (column 6, lines 46-67).

- 10. With regard to claims 10, 11, and 12, it is understood that the process of figures 7A-7F may be implemented for a dual or triple damascene structure. Furthermore figures 7A-7F show damascene structures which include a plurality of damascene levels.
- 11. In reference to claims 13, 14, and 15, figures 7A-7F makes it clear that the reducing plasma process and the formation of the damascene opening occur in the same environment or chamber (column 8, lines 51-67; column 9, lines 1-57). The chamber is a substantially vacuum environment (column 9, lines 21-29).
- 12. With regard to claim 16, Aoki discloses that forming the damascene opening and exposing the metallic layer to the reducing plasma are carried out in an environment having less oxygen than ambient air (column 9, lines 21-29).
- 13. With regard to claim 20, a diffusion barrier (20) is formed over the damascene structure before forming the metallic plug (22).
- 14. In reference to claim 22, Aoki discloses the use of a wet cleaning process (column 9, lines 34-38).
- 15. With regard to claims 24 and 25, the metallic plug (22) uses copper (column 9, lines 49-55), which is the same material as the metallic layer (3).

Claim Rejections - 35 USC § 103

16. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 17. Claims 17 and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Aoki et al. (USPN 6,465,352 B1).
- 18. In reference to claims 17 and 18, Aoki discloses that the plasma process occurs for a duration of 30 seconds to 10 minutes (column 7, lines 35-38). The applicant has claimed ranges of "about 10 to about 60 seconds" and "about 10 to about 30 seconds." However the examiner would like to note:

In the case where the claimed ranges "overlap or lie inside ranges disclosed by the prior art" a prima facie case of obviousness exists. In re Wertheim, 541 F.2d 257, 191 USPQ 90 (CCPA 1976); In re Woodruff, 919 F.2d 1575, 16 USPQ2d 1934 (Fed. Cir. 1990). See MPEP 2144.05.

Thus claims 17 and 18 do not distinguish over the prior art reference of Aoki.

- 19. Claim 19 is rejected under 35 U.S.C. 103(a) as being unpatentable over Aoki et al. (USPN 6,465,352 B1).
- 20. In reference to claim 19, Aoki discloses that the reducing plasma is provided at a pressure of 0.1 Torr to 1 Torr which is 100 milliTorr to 1000 milliTorr (column 7, lines 32-
- 34). The applicant has claimed a pressure of "about 100 milliTorr." However the examiner would like to note:

In the case where the claimed ranges "overlap or lie inside ranges disclosed by the prior art" a prima facie case of obviousness exists. In re Wertheim, 541 F.2d 257, 191 USPQ 90 (CCPA 1976); In re Woodruff, 919 F.2d 1575, 16 USPQ2d 1934 (Fed. Cir. 1990). See MPEP 2144.05.

Thus claim 19 does not distinguish over the prior art reference of Aoki.

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- 21. Claim 21 is rejected under 35 U.S.C. 103(a) as being unpatentable over Aoki et al. (USPN 6,465,352 B1) in view of Yamasaki et al. (United States Patent Application Publication No. US 2001/0034127 A1).
- 22. With regard to claim 21, Aoki does not disclose the use of a tungsten nitride diffusion barrier. However the use of a tungsten nitride diffusion barrier is well known in the art. Yamasaki et al. (United States Patent Application Publication No. US 2001/0034127 A1, hereinafter referred to as the "Yamasaki" reference) discloses that tungsten nitride diffusion barriers have the benefit of good step coverage which is desired in the art (p.1, paragraph 12). In view of Yamasaki, it would therefore be obvious to use tungsten nitride as the diffusion barrier in the Aoki device.
- 23. Claim 23 is rejected under 35 U.S.C. 103(a) as being unpatentable over Aoki et al. (USPN 6,465,352 B1) in view of Andrews et al. (USPN 6,270,353 B1).
- 24. With regard to claim 23, Aoki does not disclose the use of an aqueous dilute hydrofluoric acid for the wet cleaning process. However the use of an aqueous dilute hydrofluoric acid in a wet cleaning process is well known in the art. Andrews et al. (USPN 6,270,353 B1, hereinafter referred to as the "Andrews" reference) discloses that a hydrofluoric acid wet etch process has the advantage of being a quick and low cost process (column 4, lines 6-9). In view of the benefits disclosed by Andrews, it would therefore be obvious to use an aqueous dilute hydrofluoric acid for the wet cleaning process in the method of Aoki.

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#### Conclusion

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin Quinto whose telephone number is (571) 272-1920. The examiner can normally be reached on M-F 8AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue Purvis can be reached on (571) 272-1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

**KVQ**